**CLAIM AMENDMENTS:**

Claim 1 (Currently Amended): An LED backlight module, comprising:

a printed circuit board;

a plurality of LEDs disposed on the printed circuit board, and being arranged on the printed circuit board in a matrix; and

a light transmissive material coating on the printed circuit board, wherein the LEDs are embedded in the light transmissive material.

Claim 8 (Currently Amended): The LED backlight module as claimed in claim ~~5~~ 7, wherein the LEDs are arranged on the printed circuit board in a matrix.

Claim 21 (Original): The LED backlight module as claimed in claim 1, wherein the LEDs are disposed on the printed circuit board by means of Surface Mount Technology (SMT).

Claim 3 (Original): The LED backlight module as claimed in claim 1, wherein the printed circuit board has a reflective material disposed thereon to reflect light.

Claim 7 (Currently Amended): ~~The~~ An LED backlight module, comprising: ~~as claimed in claim 1 further comprising~~

a printed circuit board;

a plurality of LEDs disposed on the printed circuit board;

a light transmissive material coating on the printed circuit board, wherein the LEDs are embedded in the light transmissive material; and

a plurality of spacers implanted in the light transmissive material.

Claim 4 (Currently Amended): The LED backlight module as claimed in claim 1, ~~1~~ further comprising a plurality of spacers implanted on the surface of the light transmissive material.

Claim 5 (New): The LED backlight module as claimed in claim 1, wherein the LEDs are connected directly to the printed circuit board.

Claim 9 (New): The LED backlight module as claimed in claim 7, wherein the LEDs are connected directly to the printed circuit board.

Claim 6 (New): The LED backlight module as claimed in claim 1, further comprising a plurality of spacers implanted in the light transmissive material.